

TANK-801-BT

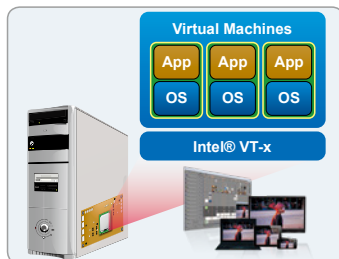
- Intel® Celeron® J1900 2 GHz, 10W
- Versatile three different backplane types

Features

- Intel® Celeron® J1900 2 GHz, 10W
- 16-bit digital I/O, 8-bit input/8-bit output
- 1 x DVI-I
1 x DisplayPort
- Various expansion type:
 - » 3A: One PCIe x1 + Two x PCI
 - » 3B: Two PCIe x1 + One x PCI
 - » 3C: Three x PCI
- Dual DC power input



Enhanced Visual Experience



Support Intel® Virtualization Technology



Automation

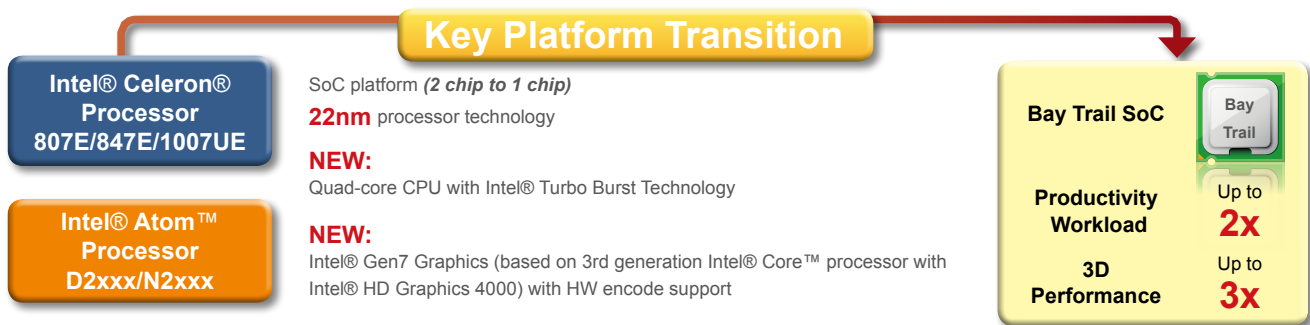


Video HD Technology
Spectacular HD Playback

Intel® Bay Trail Solution

Intel® Bay-Trail SoC (system on chip) integrates with CPU and graphics. With the Gen 7 graphics and the DX11 and full HD support, the TANK-801-BT is a good solution for visual application.

■ Intel® Bay Trail Platform Transition



■ Intel® Bay Trail Graphics and Media Features

3D Graphics	DX11.1, OGL 4.0, OGL ES 2.0, OVG 1.1
Video Decode	H.264, MPEG2, MPEG4, VC1/WMV9, VP8 up to 1080p decode
Video Encode	H.264, MPEG2

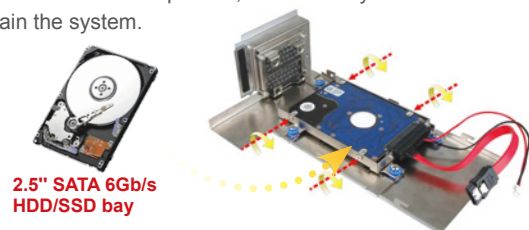
Diversified Expansion Interfaces

The TANK-801 series has three different expansion options on PCI and PCIe slot selection. Users can choose the suitable model for their application.

Backplane	TANK-801	
	Slot type	Signal
HPE-3S6 (2P1E)	PCI	PCI
	PCIe x16	PCIe x1
HPE-3S7 (1P2E)	PCI	PCI
	PCIe x4	PCIe x1
	PCIe x16	PCIe x1
HPE-3PCI	PCI	PCI

Easy of Installation

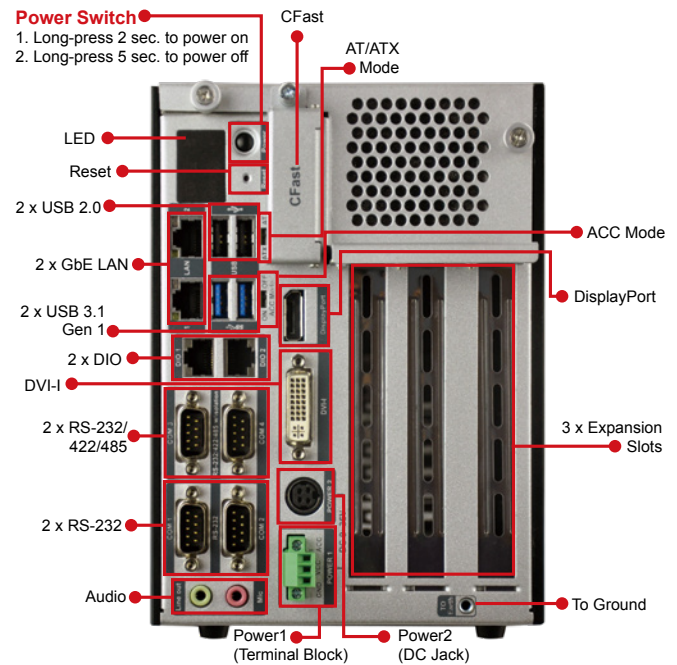
Users can easily install SO-DIMM, PCIe Mini cards and expansion cards by removing the TANK-801's top cover. A 2.5" SATA HDD/SSD bay is located on the top cover, which is very convenient for users to maintain the system.



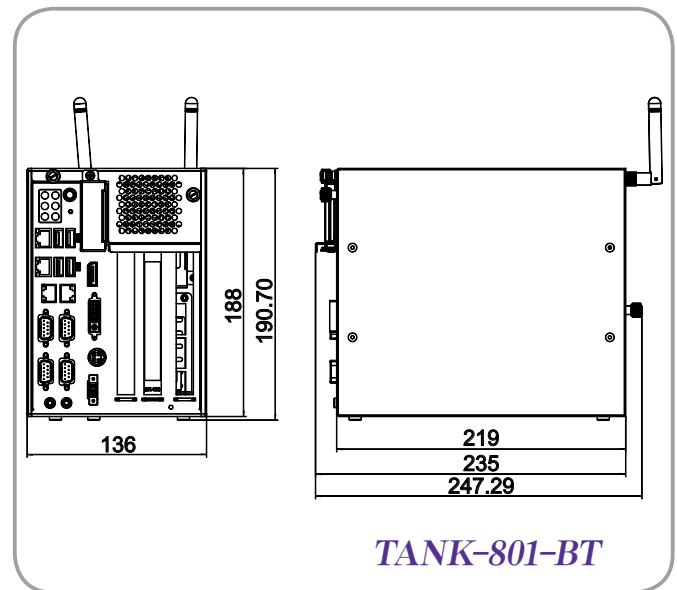
Specifications

Model Name	TANK-801-BT		
Chassis	Color	Black C + Silver	
	Dimensions (WxDxH) (mm)	136 x 219 x 188	
	System Fan	Fanless	
	Chassis Construction	Extruded aluminum alloys	
Motherboard	CPU	Intel® Celeron® J1900 2 GHz	
	Chipset	SoC	
	System Memory	1 x 204-pin DDR3L SO-DIMM, 2GB pre-installed (system max: 8 GB)	
IPMI	iRIS Solution	1 x iRIS-2400 (optional)	
Storage	Hard Drive	1 x 2.5" SATA 3Gb/s HDD/SSD bay	
	CF Card/CFast	1 x CFast	
I/O Interfaces	USB 3.1 Gen 1 (5Gb/s)	2	
	USB 2.0	2	
	Ethernet	2 x RJ-45 1 x PCIe GbE by Intel® I210 1 x PCIe GbE by Intel® I211	
	COM Port	2 x RS-232 (DB-9) 2 x RS-232/422/485 (DB-9, with isolation)	
	Digital I/O	16-bit digital I/O, 8-bit input/8-bit output	
	Display	1 x DisplayPort, 1 x DVI-I	
	Resolution	DisplayPort: Up to 2560 x 1600 MHz DVI-I: Up to 2560 x 1600 MHz	
	Audio	1 x Line-out, 1 x Mic-in	
	Wireless	1 x 802.11b/g/n (optional)	
	Expansions	PCI/PCIe	3A: One PCIe x1 + Two x PCI 3B: Two PCIe x1 + One x PCI 3C: Three x PCI
		PCIe Mini	1 x Full-size PCIe Mini
	Power	Power Input	DC Jack: 9 V~36 V DC Terminal Block: 9 V~36 V DC
		Power Consumption	19 V@1.8 A (Intel® Celeron® J1900 with 2 GB DDR3 memory)
	Reliability	Mounting	Wall mount
Operating Temperature		-20°C ~ 60°C with air flow (SSD), 5% ~ 95%, non-condensing	
Storage Temperature		-40°C ~ 85°C with air flow (SSD), 5% ~ 90%, non-condensing	
Operating Shock		Half-sine wave shock 5G, 11ms, 3 shocks per axis	
Operating Vibration		MIL-STD-810F 514.5C-2 (with SSD)	
Weight (Net/Gross)		2.8 kg/4.3 kg	
OS	Safety/EMC	CE/FCC	
	Supported OS	Microsoft® Windows® 8 Embedded, Microsoft® Windows® Embedded Standard 7 E	

Fully Integrated I/O



Dimensions (Unit: mm)



Ordering Information

Part No.	Description
TANK-801-BTI-J1/2G/3A-R12	Fanless embedded system with two PCI and one PCIe x1 expansion, Intel® Bay-Trail J1900 2 GHz, TDP 10W, 2GB DDR3L pre-installed memory, 1 x DVI-I, 1 x DisplayPort, iRIS-2400 optional, 9 V~36 V DC, RoHS
TANK-801-BTI-J1/2G/3B-R12	Fanless embedded system with one PCI and two PCIe x1 expansions, Intel® Bay-Trail J1900 2 GHz, TDP 10W, 2GB DDR3L pre-installed memory, 1 x DVI-I, 1 x DisplayPort, iRIS-2400 optional, 9 V~36 V DC, RoHS
TANK-801-BTI-J1/2G/3C-R12	Fanless embedded system with three PCI expansion, Intel® Bay-Trail J1900 2 GHz, TDP 10W, 2 GB DDR3L pre-installed memory, 1 x DVI-I, 1 x DisplayPort, iRIS-2400 optional, 9 V~36 V DC, RoHS

Options

Part No.	Description
iRIS-2400-R10	IPMI 2.0 adapter card with AST2400 BMC chip for DDR3 SO-DIMM socket interface
EMB-FAN-KIT02-R10	Fan Module;MODIFY 31100-000272-RS;+12V DC;4PIN;40*40*15mm ;STANDARD;;FD124015LB2W3;; L= 400mm MOLEX 5051-04P P=2.54;CCL;RoHS
EMB-WIFI-KIT01-R20	1T1R wifi module kit for embedded system, IEEE802.11a/b/g/n/ac WiFi with Bluetooth 4.0/3.0+HS, 1 x wifi module, 2 x 250mm RF cable, 2 x Antenna, RoHS
TPM-IN01-R20	20-pin INFINEON TPM Module,S/W managementTool,Firmware V4.4
TANK-801-BT-WES7E-R10	OS Image with Windows® Embedded Standard 7 E for TANK-801 Series, CD-ROM, RoHS

Packing List

1 x Power Adapter (With PSE & ErP Certified)	1 x Chassis Screw
1 x Power Cord	1 x Mounting Bracket